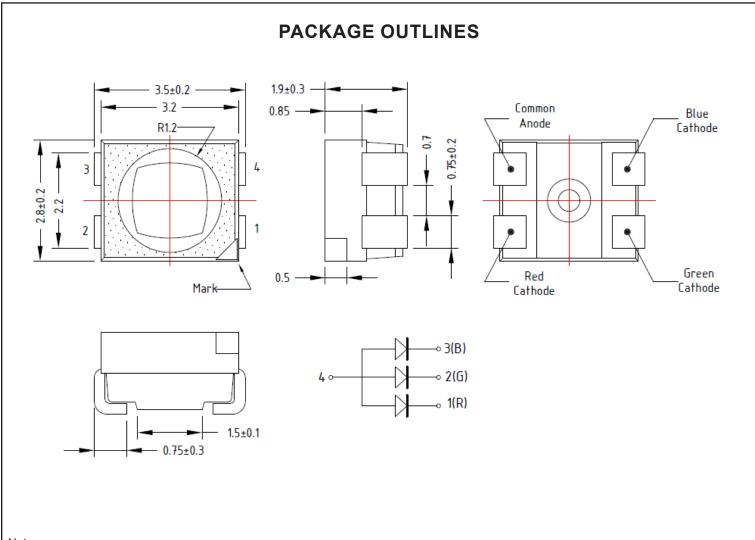


SPECIFICATION

CSPT1311R3GT3B3C



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
	InGaAlP	Red	Water Clear	120°	
CSPT1311R3GT3B3C	InGaN	True Green	Water Clear	120°	
	InGaN	Blue	Water Clear	120°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

		Max Rating			
Parameter	Symbol	Blue/ Green	Red	Unit	
Forward Current	lF	25 30		mA	
Reverse Voltage	VR	5 5		V	
Power Dissipation	Pd	90	72	mW	
Operating Temperature Range	Тор	-30~+85		°C	
Storage Temperature Range	Тѕтс	-40~+100		°C	
Peak Pulsing Current (tp \leq 10 μ S, duty cycle = 0.005)	lFP	100		mA	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Darameter	Symbol	Test Condition	Color	Value		1.1	
Parameter				Min	Тур	Max	Unit
	lv	IF = 20mA	Red	550	700	-	mcd
Luminous Intensity			Green	800	1400	-	
			Blue	250	300	-	
Forward Voltage	VF	IF = 20mA	Red	-	2.1	2.4	V
			Green	-	3.2	3.6	
			Blue	-	3.2	3.6	
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	-	120	-	Deg
	λD	IF = 20mA	Red	620	625	630	nm
Dominant Wavelength			Green	525	530	535	
			Blue	465	470	475	

^{*}Tolerance of viewing angle: -10 / +5 deg.



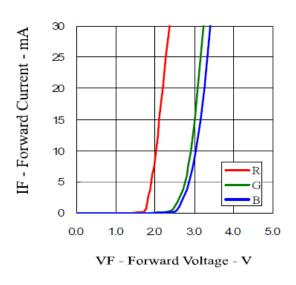
^{*}Tolerance of forward voltage is -/+ 0.05V

^{*}Tolerance of luminous intensity -/+ 1nm

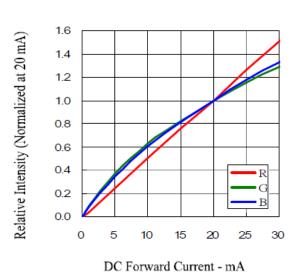


TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

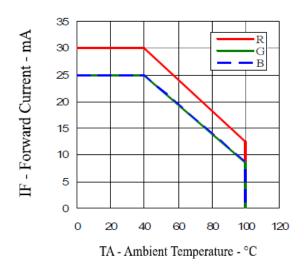
Forward Current vs. Forward Voltage



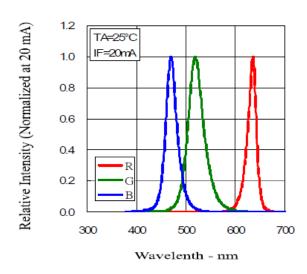
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature

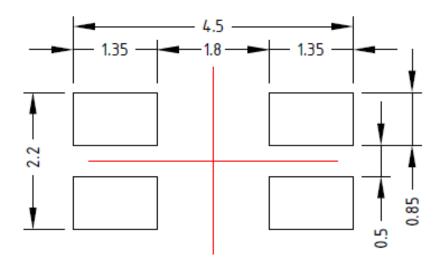


Relative Intensity vs. Wavelength





RECOMMENDED SOLDERING PATTERN



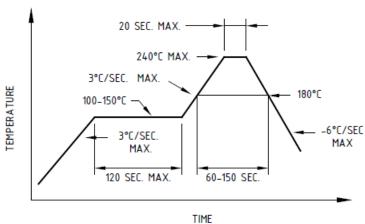
Notes:

- 1. All dimensions in mm.
- 2. Electrical connection between all cathodes is recommended.

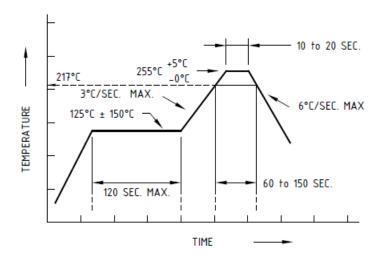


SOLDERING CONDITIONS

SOLDERING CONDITIONS



Recommended reflow soldering profile



Recommended Pb-free reflow soldering profile

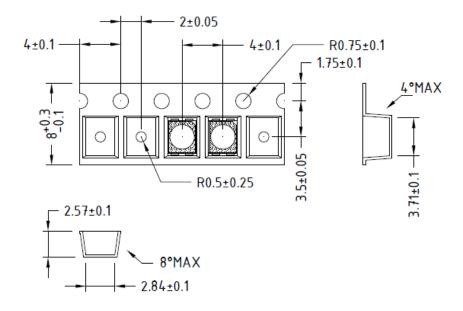
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a
 double-head soldering iron should be used. It should be confirmed beforehand whether the
 Characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.





REEL PACKAGING

TAPE DIMENSION



TAPE LEADER AND TRAILER DIMENSION

